BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin





ATS Part#: ATS010010023-SF-1V

Description: 10.00 x 10.00 x 23.00 mm BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin

Heat Sink Type: Straight Fin
Heat Sink Attachment: superGRIP
Equivalent Part Number: N/A

*Image above is for illustration purpose only.

Features & Benefits

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- Features a low profile, slant fin array that offers many of the performance benefits of maxiFLOW™ at a great value
- · Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks
- · Comes standard without interface material or with most common pressure sensitive thermal tapes as a custom option

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	13.83 °C/W	11.5 °C/W	10.2 °C/W	9.3 °C/W	8.6 °C/W	8.1 °C/W	7.6 °C/W
	Ducted Flow	10.6	9.1	8.2	7.5	7	6.6	6.3

Product Detail





